



# MIC94030/94031

## TinyFET™ P-Channel MOSFET

### Preliminary Information

#### General Description

The MIC94030 and MIC94031 are 4-terminal silicon gate P-channel MOSFETs that provide low on-resistance in a very small package.

Designed for high-side switch applications where space is critical, the MIC94030/1 exhibits an on-resistance of typically  $0.75\Omega$  at 4.5V gate-to-source voltage. The MIC94030/1 also operates with only 2.7V gate-to-source voltage.

The MIC94030 is the basic 4-lead P-channel MOSFET. The MIC94031 is a variation that includes an internal gate pull-up resistor that can reduce the system parts count in many applications.

The 4-terminal SOT-143 package permits a substrate connection separate from the source connection. This 4-terminal configuration improves the  $\theta_{JA}$  (improved heat dissipation) and makes analog switch applications practical.

The small size, low threshold, and low  $R_{DS(on)}$  make the MIC94030/1 the ideal choice for PCMCIA card sleep mode or distributed power management applications.

#### Features

- 13.5V minimum drain-to-source breakdown
- $0.75\Omega$  typical on-resistance at 4.5V gate-to-source voltage
- $0.45\Omega$  typical on-resistance at 10V gate-to-source voltage
- Operates with 2.7V gate-to-source voltage
- Separate substrate connection for added control
- Industry's smallest surface mount package

#### Applications

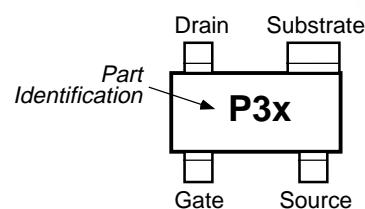
- Distributed power management
- PCMCIA card power management
- Battery-powered computers, peripherals
- Hand-held bar-code scanners
- Portable communications equipment

#### Ordering Information

Part Number	Temperature Range*	Package
MIC94030BM4	-55°C to +150°C	SOT-143
MIC94031BM4	-55°C to +150°C	SOT-143

\* Operating Junction Temperature

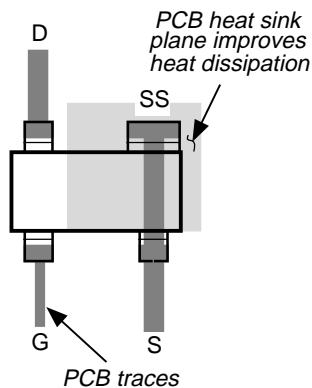
#### Pin Configuration



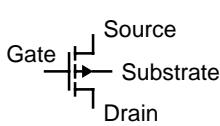
Part Number	Identification
MIC94030BM4	P30
MIC94031BM4	P31

SOT-143 Package (M4)

#### Typical PCB Layout

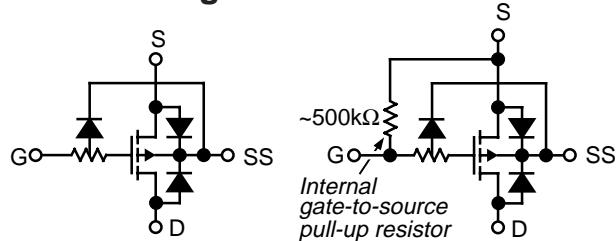


#### Schematic Symbol



Schematic Symbol

#### Functional Diagrams



MIC94030

MIC94031

## Absolute Maximum Ratings

*Voltage and current values are negative. Signs not shown for clarity.*

Drain-to-Source Voltage (pulse) ..... 16V

Gate-to-Source Voltage (pulse) ..... 16V

Continuous Drain Current

$T_A = 25^\circ\text{C}$  ..... 1A

$T_A = 100^\circ\text{C}$  ..... 0.5A

Operating Junction Temperature .....  $-55^\circ\text{C}$  to  $+150^\circ\text{C}$

Storage Temperature .....  $-55^\circ\text{C}$  to  $+150^\circ\text{C}$

Total Power Dissipation

$T_A = 25^\circ\text{C}$  ..... 568mW

$T_A = 100^\circ\text{C}$  ..... 227mW

Thermal Resistance

$\theta_{JA}$  .....  $220^\circ\text{C/W}$

$\theta_{JC}$  .....  $130^\circ\text{C/W}$

Lead Temperature

$1/16"$  from case, 10s .....  $+300^\circ\text{C}$

## Electrical Characteristics

*Voltage and current values are negative. Signs not shown for clarity.*

Symbol	Parameter	Condition (Note 1)	Min	Typ	Max	Units
$V_{BDSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}$ , $I_D = 250\mu\text{A}$	13.5			V
$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250\mu\text{A}$	0.6	1.0	1.4	V
$I_{GSS}$	Gate-Body Leakage	$V_{DS} = 0\text{V}$ , $V_{GS} = 12\text{V}$ , Note 2, Note 3			1	$\mu\text{A}$
$R_{GS}$	Gate-Source Resistor	$V_{DS} = 0\text{V}$ , $V_{GS} = 12\text{V}$ , Note 2, Note 4	500	750	1000	$\text{k}\Omega$
$C_{ISS}$	Input Capacitance	$V_{GS} = 0\text{V}$ , $V_{DS} = 12\text{V}$		100		pF
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 12\text{V}$ , $V_{GS} = 0\text{V}$			25	$\mu\text{A}$
		$V_{DS} = 12\text{V}$ , $V_{GS} = 0\text{V}$ , $T_J = 125^\circ\text{C}$		0.010	250	$\mu\text{A}$
$I_{D(ON)}$	On-State Drain Current	$V_{DS} = 10\text{V}$ , $V_{GS} = 10\text{V}$ , Note 5		6.3		A
$R_{DS(ON)}$	Drain-Source On-State Resist.	$V_{GS} = 10\text{V}$ , $I_D = 100\text{mA}$		0.45		$\Omega$
		$V_{GS} = 4.5\text{V}$ , $I_D = 100\text{mA}$		0.75		$\Omega$
		$V_{GS} = 2.7\text{V}$ , $I_D = 100\text{mA}$		1.20		$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 10\text{V}$ , $I_D = 200\text{mA}$ , Note 5		480		mS

Note 1  $T_A = 25^\circ\text{C}$  unless noted. Substrate connected to source for all conditions

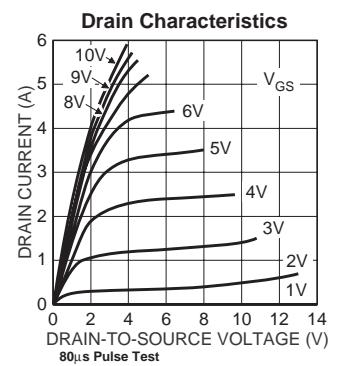
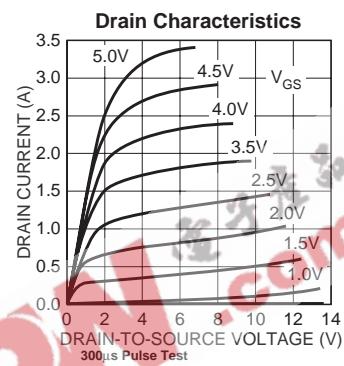
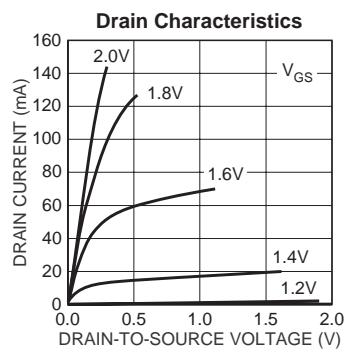
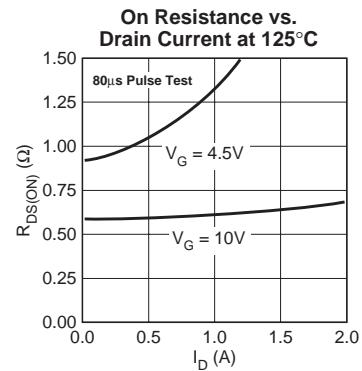
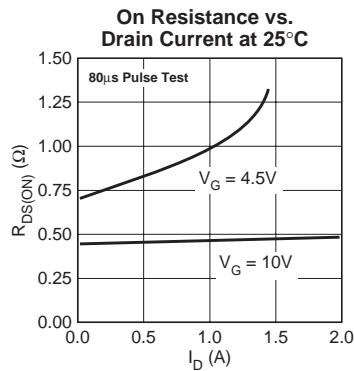
Note 2 ESD gate protection diode conducts during positive gate-to-source voltage excursions.

Note 3 MIC94030 only

Note 4 MIC94031 only

Note 5 Pulse Test: Pulse Width  $\leq 80\mu\text{sec}$ , Duty Cycle  $\leq 0.5\%$

## Typical Characteristics



## Typical Applications

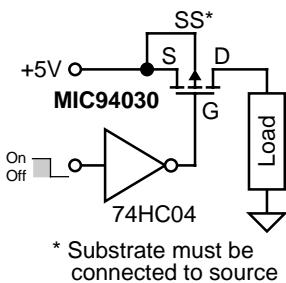


Figure 1. Power Switch Application

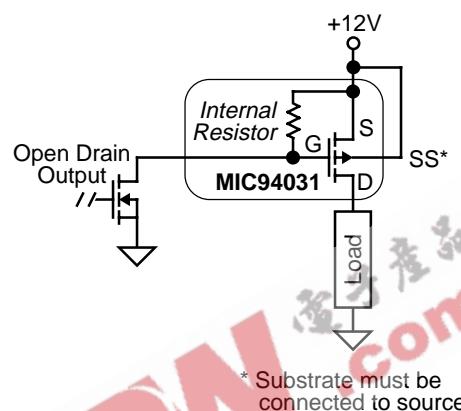


Figure 2. Power Control Application

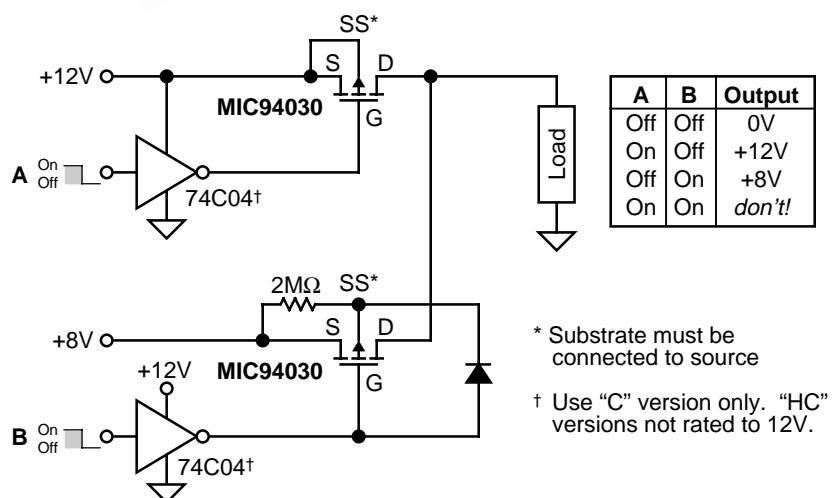


Figure 3. Analog Switch Application